

Phenom ParticleX AM

Multi-purpose desktop SEM delivering
purity at microscale





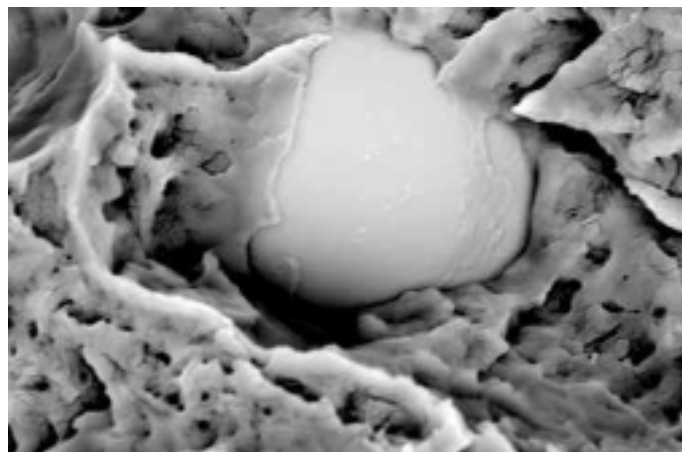
SEM image of Zinc-Phosphate on sheet metal

A growing number of manufacturing companies are establishing scanning electron microscopy (SEM) systems in-house. This trend, from outsourcing to in-house analysis, is growing and the benefits, such as the ability to perform a broad range of automated desktop analyses, chemical classification and verification according to specific norms are clear. Timely and accurate quality control are prerequisites for today's manufacturing. The Thermo Scientific™ Phenom™ ParticleX is a versatile desktop SEM solution for high quality analysis in-house. It gives you the ability to carry out speedy analysis, verification and classification of materials, supporting your production with fast, accurate and trusted data. The system is automated and offers multiple sample analysis, making testing and classification up to 10 times faster. Outsourcing typically takes up to 10 working days, whereas the Phenom ParticleX gives you certainty within one day. The system is simple to operate and fast to learn, opening up the use of particle and material analysis to a wider group of users in-house. In addition to eliminating the need to outsource, the Phenom ParticleX ease-of-use and automation allows you to offload sample analysis from other SEMs in your laboratory.

Phenom Particle X not only provides high quality SEM analysis, it is also designed to perform a number of specific functions. These include particle analysis of metal powders at the microscale for the additive industry, and confirming that components fulfill technical cleanliness specifications according to VDA19 or ISO16232 standards. All now made possible in-house and on your desktop.

Phenom ParticleX: general SEM usage

The Phenom ParticleX features a chamber including an accurate and fast motorized stage that allows analysis of samples of up to 100 mm x 100 mm. In spite of this larger sample size, a proprietary loading shuttle keeps the vent/load cycle to an industry leading sample loading time of 40 seconds or less. In practice this improves the throughput factors higher than other SEM systems.



SEM image of undesired particle within polymeric matrix

The user interface is based on the proven ease of use technology applied in the successful Phenom desktop SEM products. The interface enables both existing and new users to quickly become familiar with the system with a minimum of training.

The standard detector in the Phenom ParticleX is a four-segment backscattered electron detector (BSD) that yields sharp images and provides chemical contrast information together with a fully integrated Energy Dispersive X-ray (EDX) system for elemental analysis. A Secondary Electron Detector (SED) for surface sensitive imaging is optional.

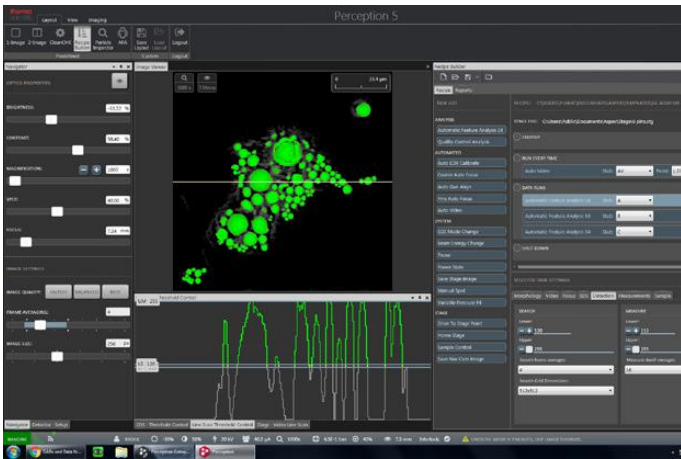
Elemental analysis is provided by EDX technology, which allows users to analyze the chemical composition of their samples. Detailed chemical composition can be obtained from a micro volume via a spot analysis. Elemental distribution can be visualized with the elemental mapping option.

Elemental Mapping and Line Scan

The Elemental Mapping functionality visualizes the distribution of elements throughout the sample. The selected elements can be mapped at a user specified pixel resolution and acquisition time. The real time mapping algorithm shows live build up of the selected elements. For a user, it is simply click and go to work with the Elemental Mapping and Line Scan functionality of the Phenom ParticleX desktop SEM. The Line Scan functionality shows the quantified element distribution in a line plot. This is especially useful for coatings, paints and other applications with multiple layers for analyzing edges, coatings, cross sections and other. Results of both the Elemental Mapping and Line Scan functionality can be easily exported by using an automated report template.

Secondary Electron Detector

A secondary electron detector (SED) is optionally available on the Phenom ParticleX. The SED collects low energy electrons from the top surface layer of the sample. It is therefore the perfect choice to reveal detailed sample surface information. The SED can be of great use for applications where topography and morphology are important. This is often the case when studying microstructures, fibers or particles.

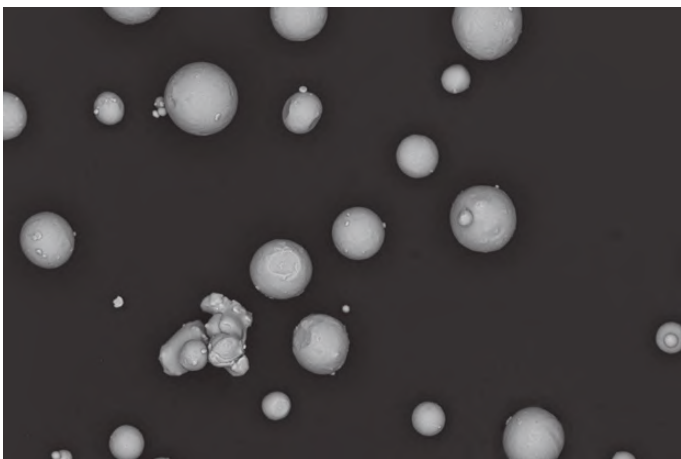


Specific parameters can be individually set

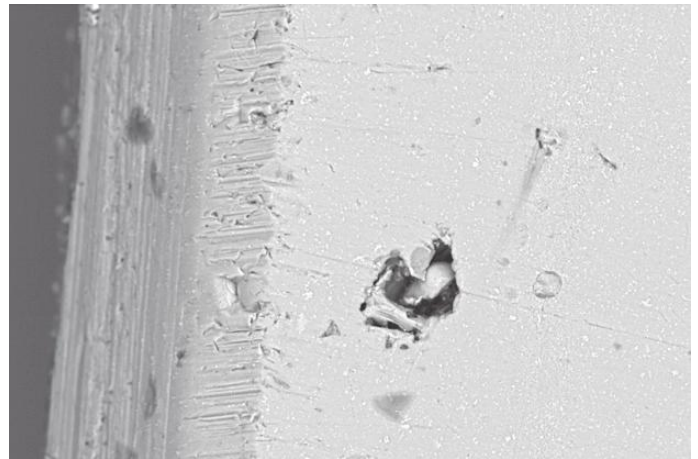
Phenom ParticleX - Additive Manufacturing

The ParticleX for Additive Manufacturing enables automated Scanning Electron Microscopy with EDX Spectrometry. The Phenom ParticleX - Additive Manufacturing is the proven solution for monitoring the three most critical characteristics of metal powders for powder-bed and powder-fed additive manufacturing processes. Monitor particle size distributions, individual particle morphology and identify foreign particles.

The Phenom ParticleX - Additive Manufacturing measures various size and shape parameters, such as minimum and maximum diameter, perimeter, aspect ratio, roughness, and feret diameter. All of which can be displayed with 10%, 50%, 90% values (e.g. d10, d50, d90).



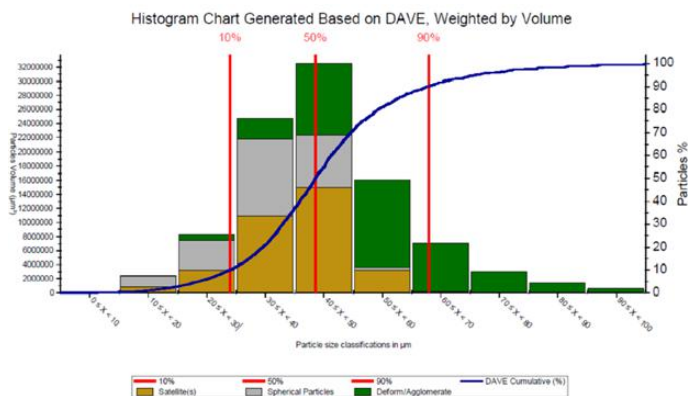
Detect particles, satellites and conglomerates



Poor powder characteristics can lead to 3D-printed failures

The supplied analysis recipes allows you to differentiate between satellite particles, spherical particles and deformed particles. Particles Size Distributions can be plotted as number based or volume based.

The integrated EDX allows chemical typing of each individual particle. Allowing you to readily identify any foreign particulate in your powder from previous printing cycles.



Plot powder size distributions as volume based or number based

Imaging Specifications	
Imaging modes	
Light optical	Magnification range: 3 - 16x
Electron optical	<ul style="list-style-type: none"> Magnification range: 80 - 100.000x Digital zoom max. 12x
Illumination	
Light optical	Bright field / dark field modes
Electron optical	<ul style="list-style-type: none"> Long lifetime thermionic source (CeB₆) Multiple beam currents
Acceleration voltages - Phenom UI	<ul style="list-style-type: none"> Default: 5 kV, 10 kV and 15 kV Advanced mode: adjustable range between 4.8 kV and 20.5 kV imaging and analysis mode
Vacuum levels	Low - medium - high
Resolution	<14 nm
Acceleration voltages Technical cleanliness EDX analyses	15 kV
Detector	
Standard	<ul style="list-style-type: none"> Backscattered electron detector Energy Dispersive Spectroscopy detector
Optional	Secondary electron detector
Digital image detection	
Light optical	Proprietary high resolution color navigation camera, single shot
Electron optical	High sensitivity backscattered electron detector (compositional and topographical modes)
Image formats	
JPEG, TIFF, BMP	
Image resolution options	
456 x 456, 684 x 684, 1024 x 1024 and 2048 x 2048 pixels	
Data storage	
USB flash drive, Network, Workstation	
Sample stage	
Computer-controlled motorized X and Y	
Sample size	
<ul style="list-style-type: none"> Max. 100 mm x 100 mm (up to 36 x 12 mm pin stubs) Max. 65 mm (h) 	
Scan area	
<ul style="list-style-type: none"> 50 mm x 50 mm 100 mm x 100 mm (optional) 	
Sample loading time	
Light optical	<5 s
Electron optical	<40 s

EDX Specifications	
Hardware	
Detector type	<ul style="list-style-type: none"> Silicon Drift Detector (SDD) Thermoelectrically cooled (LN₂ free)
Detector active area	25 mm ²
X-ray window	Ultra thin Silicon Nitride (Si ₃ N ₄) window allowing detection of elements B to Am
Energy resolution	Mn Kα ≤132 eV
Processing capabilities	Multi-channel analyzer with 2048 channels at 10 eV/ch
Max. input count rate	300.000 cps
Hardware integration	Fully embedded
Software	
<ul style="list-style-type: none"> Integrated column and stage control Auto-peak ID Iterative strip peak deconvolution Confidence of analysis indicator Export functions: CSV, JPG, TIFF, ELID, EMSA 	
Report	
Docx format	
Elemental Mapping & Line Scan Specifications	
Elemental Mapping	
Element selection	10 individual user specified maps, plus backscatter image and mix-image
Backscatter image and mix-range	
Selected area	Any size, rectangular
Mapping resolution range	16 x 16 - 1024 x 1024 pixels
Pixel dwell time range	1 - 250 ms
Line Scan	
Line Scan resolution range	16 - 512 pixels
Points dwell time range	50 - 250 ms
Total number of lines	12
Report	
Docx format	
SED Specifications	
Detector type	
Everhart Thornley	

System Specifications

Dimensions & weight

Imaging module	316(w) x 587(d) x 625(h) mm, 75 kg
Diaphragm vacuum pump	145(w) x 220(d) x 213(h) mm, 4.5 kg
Power supply	156(w) x 300(d) x 74(h) mm, 3 kg
Monitor	531.5(w) x 515.4(h) x 250(d) mm, 6.7 kg
Workstation	169(w) x 456(d) x 432(h) mm, 15 kg

Requirements

Ambient conditions

Temperature	15°C ~ 30°C (59°F ~ 86°F)
Humidity	<80% RH
Power	Single phase AC 110 - 240 Volt, 50/60 Hz, 300 W (max.)

Recommended table size

150 x 75 cm, load rating of 150 kg

Workstation Specifications

- HP-PC Tower PC
- CPU Intel Xeon E5-1620
- RAM 16 GB
- SSD 2 x 1TB
- USB Keyboard; USB Mouse
- Microsoft Windows® 10 Enterprise Edition (64-bit)
- ParticleX Software preinstalled, full license code included
- ProSuite Framework preinstalled, full license code included-
Automated Image Mapping- Remote UI

